Voltage Rating:

Resistors shall have a rated direct-current (DC) continuous working voltage or an approximate sine-wave root-mean-square (RMS) alternating-current (AC) continuous working voltage at commercial line frequency and waveform corresponding to the power rating , as determined from the following formula:

$$RCWV = \sqrt{P \times R}$$

Where:

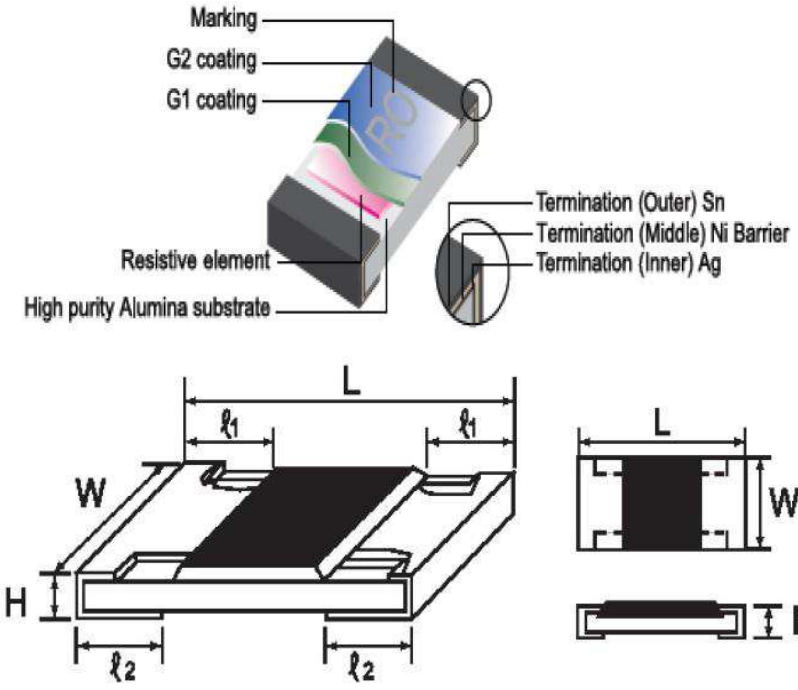
RCWV = Rated DC or RMS AC continuous working voltage at commercial-line frequency and waveform (volt)

P = Power Rating (watt)

R = Nominal Resistance (ohm)

In no case shall the rated DC or RMS AC continuous working voltage be greater than the applicable maximum value.

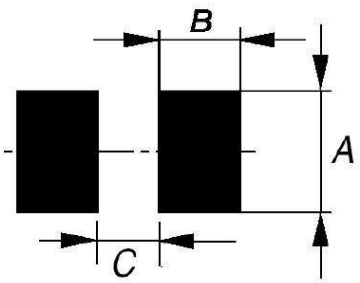
Construction & Dimensions:



Dimensions: (mm)

L	W	H	ℓ1	ℓ2
6.35±0.10	3.20±0.20	0.55±0.10	0.60±0.25	0.50±0.20

Recommended solder pad



A Width (mm)	B Pad (mm)	C Spacing (mm
3.0	1.5	5.0

4 layers PCB specification:

1) Outside 2 layers (Top and Bottom) with copper foil thickness at 2oz.

2) Inside 2 layers (Middle layers) with copper foil thickness at 4 oz.

Marking:

For E24 series Values three digit marking, the first two digits are significant figures and the third denoting number of zeros.

E.G. 333 33KΩ

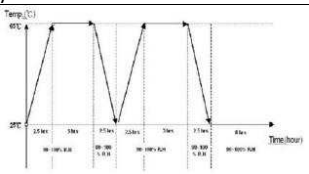
For Ohmic Values below 10Ω

E.G. 3R3 3.3Ω

For E96 Values four digit marking, the first three showing significant figures and the fourth showing number of zeros. As previously letter R is for decimal point.

E.G. 4992 49K9Ω

Performance Specification:

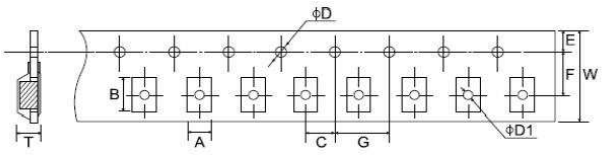
Characteristics	Limits	Test Methods
Operational life	±(1%+0.1Ω)max	125°C, at 35% of operating power, 1000H (1.5 hours "ON", 0.5 hour "OFF"). **(MIL-STD-202)**
	<100mΩ	Apply to rate current for 0Ω
Electrical Characterisation	0.1Ω<R≤0.976Ω ±100PPM 1Ω ≦ R ≤10Ω ≤ ±400PPM/°C 10Ω < R ≦100Ω ≤ ±200PPM/°C 100Ω<R≦10MΩ ≤ ±100PPM/°C	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures. (User Spec)
External Visual	No Mechanical Damage	Electrical test not required. Inspect device construction, marking and workmanship **(MIL-STD-883 Method 2009)**
Physical Dimension	Reference 2.0 Dimension Standards	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical test not required. **(JESD22 MH Method JB-100)**
Resistance to Solvent	Marking Unsmeared	Note: Add Aqueous wash chemical – OKEM Clean or equivalent. Do not use banned solvents. **(MIL-STD-202 Method 215)**
Terminal Strength	Not broken	Force of 1.8kg for 60 seconds. **(JIS-C-6429)**
High Temperature Exposure (Storage)	Resistance change rate is ± (0.5%+0.1Ω) Max.	1000hrs. @T=155°C.Unpowered. Measurement at 24±2 hours after test conclusion. **(MIL-STD-202 Method 108)**
	<50mΩ	Apply to rate current for 0Ω
Temperature cycling	Resistance change rate is ± (0.5%+0.1Ω) Max.	1000 Cycles (-55°C to +155°C). Measurement at 24±2 hours after test conclusion **(JESD22 Method JA-104)**
	<50mΩ	Apply to rate current for 0Ω
Moisture Resistance	Resistance change rate is ± (0.5%+0.1Ω) Max.	 T=24 hours /cycle. Unpowered. Measurement at 24±2 hours after test conclusion. **(MIL-STD-202 Method 106)**
	<50mΩ	Apply to rate current for 0Ω
Biased Humidity	Resistance change rate is ± (1%+0.1Ω) Max	10% rated power, 85°C/85%RH, 1000H. Measurement at 24 hours after test conclusion. **(MIL-STD-202 Method 103**)
	<100mΩ	Apply to rate current for 0Ω
Mechanical Shock	±(1%+0.1Ω) max	Wave Form: Tolerance for half sine shock pulse. Peak value is 100g's. Normal duration (D) is 6. **(MIL-STD-202 Method 213)**
Vibration	±(1%+0.1Ω) max	5g's for 20 min., 12cycle each of 3 orientations. Note: Use 8"*5"PCB. 031" thick 7 secure points (onone) long side and 2 secure points at corners of opposite sides. Parts mounted within 2' from any secure point. Test from 10-2000Hz. **(MIL-STD-202 Method 204)**

Performance Specification (continued)

Characteristics	Limits	Test Methods
Thermal Shock	±(1%+0.1Ω) max	-55°C/+155°C Note: Number of cycles required -300, Maximum transfer time -20 seconds, Dwell time -15 minutes. Air-Air. **(MIL-STD-202 Method 107)**
	<50mΩ	Apply to rate current for 0Ω
ESD	±(10%+0.1W)max	With the electrometer in direct contact with the discharge tip, verify the voltage setting at levels of ±500V,±1KV, ±2KV, ±4KV, ±8KV, The electrometer reading shall be within ±10% for voltages from 500V to ≦800V. **(AEC-Q200-002)**
Solderability	95% coverage Min.	For both leaded & SMD. Electrical test not required Magnification 50X. Conditions: a) Method B 4hrs at 155°C dry heat, the dip in bath with 245°C,5s. b) Method B: at 215°C,5s. c) Method D: at 260°C, 60s. **(J-STD-002)**
Flammability	No ignition of the tissue paper or scorching of the pinewood board	V-0 or V-1 are acceptable. Electrical test not required. (**UL-94)**
Board Flex	±(1%+0.05W)max	2mm (Min) **(JIS-C-6429)**
	<50mW	Apply to rate current for 0 W
Flame Retardance	No flame	Temperature sensing at 500□, Voltage power subjected to 32VDC current clamped up to 500ADC and decreased in 1.0VDC/hour. **(AEC-Q200-001)**
Resistance to soldering Heat	±(1%+0.05Ω)max.	Condition B No per-heat of samples. Note: Single Wave Solder-Procedure 2 for SMD and Procedure 1 for Leaded with solder within 1.5mm of device body. **(MIL-STD-202 Method 210)**
	<50mW	Apply to rate current for 0 W
* Sulfuration test: H2S 3~5PPM 50°C±2°C 91%~93%RH 1000H		

Packaging specification

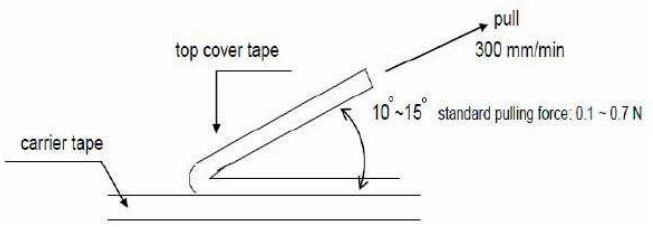
Embossed Taping:



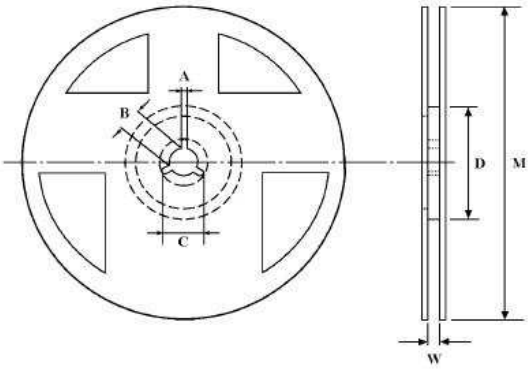
A ±0.2	B ±0.2	C ±0.05	ØD+0.1 -0	ØD1+0.1 -0	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ± 0.1
3.50	6.70	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0

Peeling Strength of Top Cover Tape

Test Condition: 0.1 to 0.7 N at a peel-off speed of 300 mm / min.



Reel Dimensions



Tape	Reel Qty	A ± 0.5	B ± 0.5	C ± 0.5	D ± 1	M ± 2	W ± 1
Embossed	4,000	2	13	21	60	178	13.8

Environment Related Substance

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs), Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

Storage Condition

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of 25°C ± 10°C and a relative humidity of 60%RH ± 10%RH, chemical and dust free atmosphere

Even within the above guarantee periods, do not store these products in the following conditions, otherwise their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2

2. In direct sunlight

AEC-Q200

The 3521 series is qualified to AEC-Q200 standard at Grade"4"

How To Order

3521	10K	F	T
Common Part	**Resistance Value**	**Tolerance**	**Pack Style**
3521 – SMD Power Resistor	1Ω - 1R0 100Ω - 100R 1,000Ω (1KΩ) -1K0 10,000Ω (10KΩ) - 10K 1,000,000Ω (1MΩ) - 1M0	F – 1%	T – 4000 Reel

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

TE Connectivity:

352110RFT